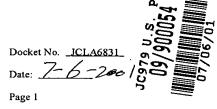


PATENT



## ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Yi-Chuan Ding, In-De Ou, Kun-Ching Chen, Yung-I Yeh

For: FLIP CHIP PROCESS

Enclosed are:				
$\boxtimes$	Specification 12 pages.			
	_4_ Sheets of drawings			
$\boxtimes \swarrow$	Recordation Form Cover sheet with 2 pages assignment.			
	A certified copy of Taiwan Patent Application No dated _			
$\boxtimes$	SIGNED declaration and power of attorney.			
$\boxtimes$	Return Prepaid postcard.			

CLAIMS AS FILED									
FOR	NUMB	ER FII	LED	NUMBE	R EXTRA	RATE	FEE		
Basic Fee						\$710.00	\$710.00		
Total Claims	12	_	20 =	= 0	×	\$18.00	\$0.00		
Independent Claims	2		3 =	= 0	×	\$80.00	\$0.00		
If application contains any r	nultiple depende	nt claim	(s), the	en add	_	\$270.00	\$0.00		
	TOTALI	FILING	FEE				\$710.00		

A check in the amount of \$710.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

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## **CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

Docket No.	:	JCLA6831

Applicant(s) : Yi-Chuan Ding, In-De Ou, Kun-Ching Chen,

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Date of Deposit : July 6, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 12 pages, 4 sheets of drawings; SIGNED Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Michelle Chang